



A.U.E.I.
6/29/06
[Signature]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of)
)
Shunpei Yamazaki et al.)
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Serial No.: 09/544,801)
)
Filed: April 7, 2000)
)
For: Semiconductor Device And Method)
For Fabricating The Same)
)
)
Art Unit: 2826)
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)
Examiner: Fazli Erdem)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: the Assistant Commissioner for Patents , P.O. Box 1450, Alexandria, VA 22313-1450 on	
<u>June 26, 2006</u> (Date of Deposit)	
<u>Shannon Wallace</u> Name of applicant, assignee, or Registered Rep.	
<u>Shannon Wallace</u> Signature	<u>6/26/06</u> Date

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT G (AFTER FINAL)

Sir:

In response to the Final Rejection dated April 24, 2006, a RCE being filed herewith,
please amend the above-identified application as follows: